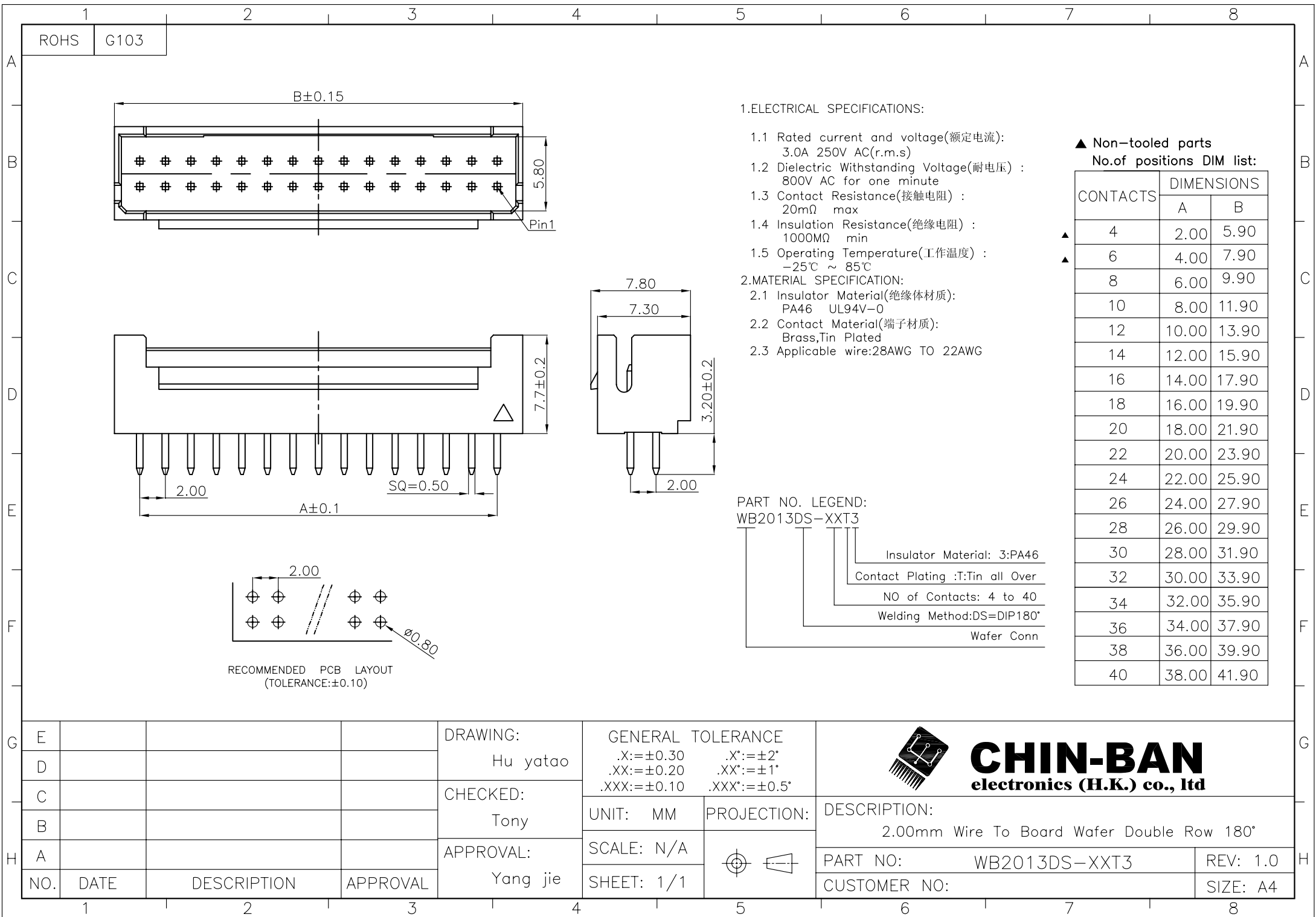




ROHS G103

B±0.15

Pin1

7.7±0.2

2.00

A±0.1

SQ=0.50

2.00

Ø0.80

RECOMMENDED PCB LAYOUT
(TOLERANCE:±0.10)

1.ELECTRICAL SPECIFICATIONS:

- 1.1 Rated current and voltage(额定电流):
3.0A 250V AC(r.m.s)
- 1.2 Dielectric Withstanding Voltage(耐电压) :
800V AC for one minute
- 1.3 Contact Resistance(接触电阻) :
20mΩ max
- 1.4 Insulation Resistance(绝缘电阻) :
1000MΩ min
- 1.5 Operating Temperature(工作温度) :
-25℃ ~ 85℃

2.MATERIAL SPECIFICATION:

- 2.1 Insulator Material(绝缘体材质):
PA46 UL94V-0
- 2.2 Contact Material(端子材质):
Brass,Tin Plated
- 2.3 Applicable wire:28AWG TO 22AWG

PART NO. LEGEND:
WB2013DS-XXT3

Insulator Material: 3:PA46

Contact Plating :T:Tin all Over

NO of Contacts: 4 to 40

Welding Method:DS=DIP180°

Wafer Conn

▲ Non-tooled parts No.of positions DIM list:

CONTACTS	DIMENSIONS	
	A	B
4	2.00	5.90
6	4.00	7.90
8	6.00	9.90
10	8.00	11.90
12	10.00	13.90
14	12.00	15.90
16	14.00	17.90
18	16.00	19.90
20	18.00	21.90
22	20.00	23.90
24	22.00	25.90
26	24.00	27.90
28	26.00	29.90
30	28.00	31.90
32	30.00	33.90
34	32.00	35.90
36	34.00	37.90
38	36.00	39.90
40	38.00	41.90

DRAWING:
Hu yatao

CHECKED:
Tony

APPROVAL:
Yang jie

GENERAL TOLERANCE

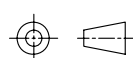
.X:=±0.30 .X*:=±2°
.XX:=±0.20 .XX*:=±1°
.XXX:=±0.10 .XXX*:=±0.5°

UNIT: MM

SCALE: N/A

SHEET: 1/1

PROJECTION:



CHIN-BAN
electronics (H.K.) co., ltd

DESCRIPTION:

2.00mm Wire To Board Wafer Double Row 180°

PART NO: WB2013DS-XXT3

REV: 1.0

CUSTOMER NO:

SIZE: A4